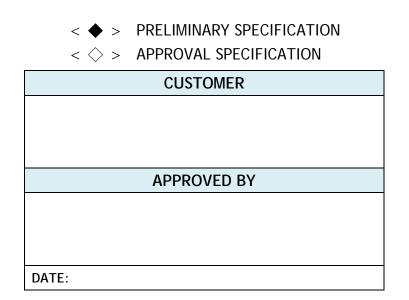


TFT Module Specification

MODEL: UC-070XIEB0GW1-S

This module uses ROHS material



DESIGNED	CHECKED	APPROVED
RD	PM	批准
2024.02.22	2024.02.22	2024.02.22
趙長慶	呂家祥	PM

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RECORD OF REVISION

Version	Revised Date	Page	Content
V1.0	2024/02/22		PRELIMINARY SPEC.



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1. GENERAL DESCRIPTION

1.1 Description

The specification is model UC-070XIEB0GW1-S is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This model is composed of a TFT LCD panel, a driving circuit, a backlight system. This TFT LCD has a 7.0 (16:9) inch diagonally measured active display area with WSVGA (1024 horizontal by 600 vertical pixels) resolution.

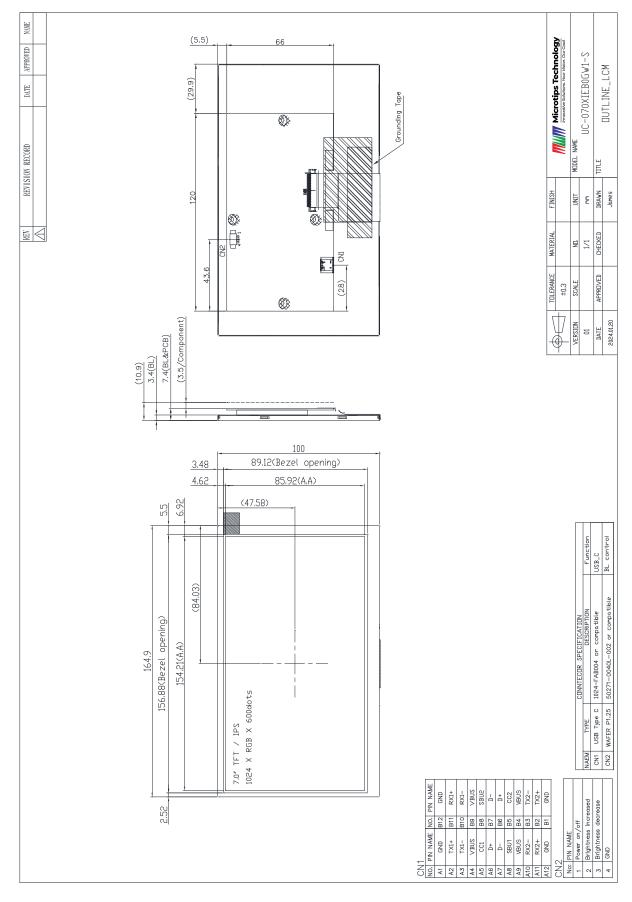
- Supports VESA DisplayPort Alt. Mode 1.0a
- DisplayPort 1.3
- Build-in OSD function.

1.2 Features:

No.	Item	Specification	Unit
1	Panel Size	7.0″	Inch
2	Number of Pixels	1024 (W) x RGB x 600 (H)	Pixels
3	Active Area	154.21 (W) × 85.92 (H)	mm
4	Pixel Pitch	0.1506 (W) x 0.1432 (H)	mm
5	Outline Dimension	164.9 (W) × 100 (H) × 10.9 (T)	mm
6	Number of Colors	16.7M	
7	Display Mode	IPS / Normally Black / Transmissive	
8	Viewing Direction	Free direction	
9	Display Format	RGB vertical stripe	
10	Surface Treatment	Anti-Glare (3H)	
11	Contrast Ratio	600 (Тур.)	
12	Luminance (cd/m^2)	700 (Тур.)	cd/m2
13	Interface	TYPE-C (5V/3A)	
14	Backlight	White LED	
15	Operation Temperature	0 ~ 70	°C
16	Storage Temperature	-30 ~ 80	°C
17	Weight	TBD	g



2. MECHANICAL SPECIFICATION



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3. PIN DESCRIPTION

3.1 TYPE-C CN1(Connector Part No: 1024-FAB004 or compatible)

Pin No.	Symbol	1/0	Function	Note
A1	GND	Р	Ground	
A2	TX1+	I/0	High speed data path TX for DP Alt Mode.	
A3	TX1-	I/0	night speed data path 1x for DF Alt mode.	
A4	VBUS	Р	Cable bus power +5V only.	
A5	CC1	I/0	Type-C Port Configuration Channel	
A6	D+	I/0	USB 2.0 Interface.	
A7	D-	I/0	USD 2.0 Interface.	
A8	SBU1	I/0	USB Type-C Sideband Use 1	
A9	VBUS	Р	Cable bus power +5V only.	
A10	RX2-	I/0	High speed data path RX for DP Alt Mode.	
A11	RX2+	I/0	Thigh speed data path KX for DF Art Mode.	
A12	GND	Р	Ground	
B1	GND	Р	Ground	
B2	TX2+	I/0	High speed data path TX for DP Alt Mode.	
B3	TX2-	I/0	Thigh speed data path TX for DF Alt mode.	
B4	VBUS	Р	Cable bus power +5V only.	
B5	CC2	I/0	Type-C Port Configuration Channel	
B6	D+	I/0	USB 2.0 Interface.	
B7	D-	I/0		
B8	SBU2	I/0	USB Type-C Sideband Use 2	
B9	VBUS	Р	Cable bus power +5V only.	
B10	RX1-	I/0	High speed data path BY for DD Alt Mode	
B11	RX1+	1/0	High speed data path RX for DP Alt Mode.	
B12	GND	Р	Ground	

3.2 key Pad CN2 (50271-0040L-002 or compatible)

Pin	Symbol	1/0	I/O Function	
1	Power on/off	Ι	Power On/Off control.	
2	Brightness increased	Ι	I Brightness Increase.	
3	Brightness decrease	I	I Brightness decrease.	
4	GND	Р	Ground	

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4. ABSOLUTE MAXIMUM RATINGS

4.1 Electrical Absolute Rating

4.1.1 TFT LCD Module

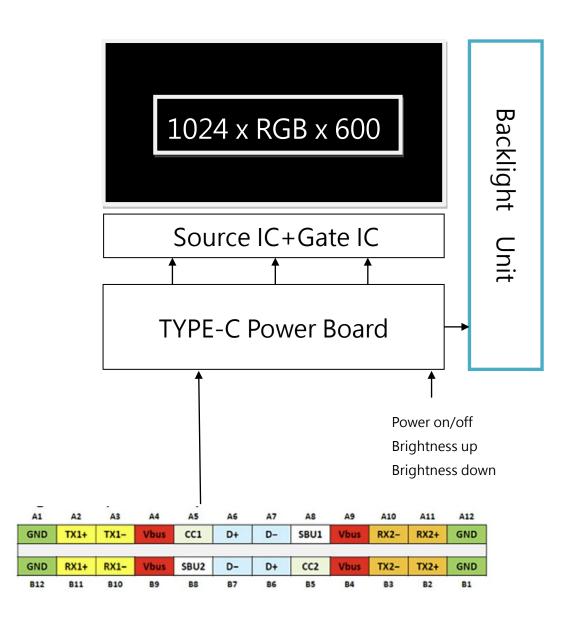
Item	Symbol	Val	ues	Unit	Note	
nem	Symbol	Min	Max.	Unit	Note	
Power supply voltage	VBUS	-0.3	6	V		

4.1.2 Environment Absolute Rating

ltom	Symbol		Values	Unit	Noto		
Item	Symbol	Min	Тур	Max.	Unit	Note	
Operating Temperature	Тора	0		70	°C	Ambient	
Storage Temperature	Tstg	-30		80	°C	temperature	



- 5. BLOCK DIAGRAM
 - 5.1 TFT LCD Module





6. ELECTRICAL CHARACTERISTICS

6.1 TFT LCD Module

Item	Symbol		Values		Unit	Note
item	Symbol	Min.	Тур.	Max.	Unit	Note
Supply Voltage	VBUS	-	5.0	5.5	V	
required current	I _{BUS}	-	650	720	mA	(1)
LED life time	-	-	50000	-	Hr	(2)

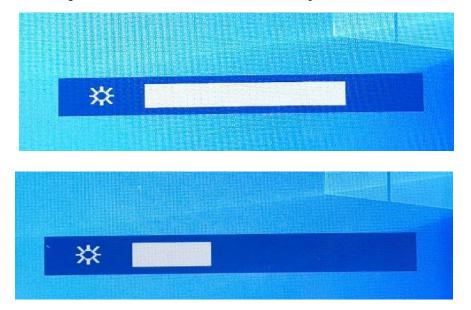
Note 1: condition: projected capacitive touch panel active, and under brightness 100%

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness that the ambient temperature is 25° C 60% RH.

6.2 OSD Function

Built-in OSD function, connected to the external key pad to CN2, can control the screen switch On/Off and backlight brightness control.

The adjusted brightness level will be automatically memorized.

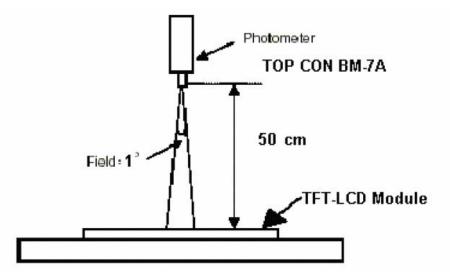


Item		Symbol	Condition	Min.	Тур.	Max.	Unit
Bright	ness			560	700		cd/m2
Unifor	mity	B-uni	Note1,	70	75	-	%
Contrast	Ratio	CR	Note 3,	400	600		
Docponer	Time	Tr	$(\theta = 0^\circ,$ Normal		4	8	ms
Response		Tf	Viewing		12	24	ms
Color	White	Wx	Angle)	0.260	0.310	0.360	
Chromaticity	white	Wy		0.280	0.330	0.380	
	Horizontal	heta x+		80	85		
View angle	ΠΟΠΖΟΠΙΔΙ	<i>θ</i> x-	Center	80	85		
	Vortical	θ Y+	CR≥10	80	85		
	Vertical	<i>θ</i> Y-		80	85		

7. OPTICAL CHARACTERISTICS

Note : The following optical specifications shall be measured in a darkroom or equivalent state(ambient luminance ≤ 1 lux, and at room temperature). The operation temperature is 25°C±2°C. The measurement method is shown in Note1.

Note 1: The method of optical measurement:





Note 3: Definition of Contrast Ratio (CR):

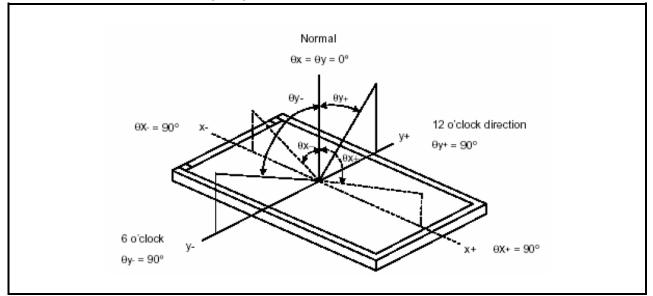
CR = Luminance with all pixels in white state \div Luminance with all pixels in Black state

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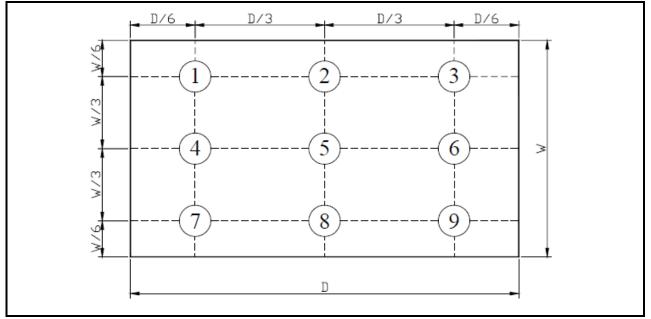
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Note 4: Definition of Viewing Angle:



Note 5: Definition of Brightness Uniformity (B-uni):

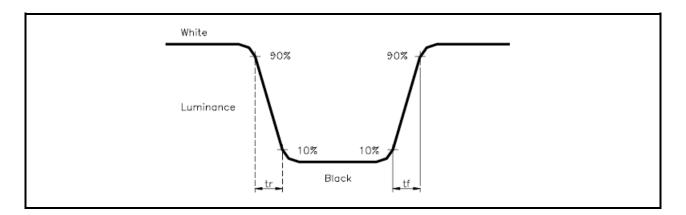


B-uni = (Minimum luminance of 9 points÷Maximum luminance of 9points)X100%



Note 6: Definition of Response Time:

The Response Time is set initially by defining the "Rising Time (Tr)" and the "Falling Time (Tf)" respectively. Tr and Tf are defined as following figure



Note 7: Definition of Chromaticity:

The color coordinates (Wx,Wy), (Rx,Ry), (Gx,Gy), and (Bx,By) are obtained with all pixels in the viewing field at white, red, green, and blue states, respectively.



8. RELIABILITY

8.2 TESTS

8.1 Test Condition

- 8.1.1 Temperature and Humidity(Ambient Temperature) Temperature : 25 ± 5°C Humidity : $65 \pm 5\%$
- 8.1.2 Operation Unless specified otherwise, test will be conducted under function state.
- 8.1.3 Container Unless specified otherwise, vibration test will be conducted to the product itself without putting it in a container.
- 8.1.4 **Test Frequency** In case of related to deterioration such as shock test. It will be conducted only once.
- ITEM CONDITION CRITERION No. 1 **High Temperature Storage** 80°C, 120 hrs 2 Low Temperature Storage -30°C, 120 hrs High Temperature Operating 3 70°C, 120 hrs 4 Low Temperature Operating 0°C, 120 hrs High Temperature/Humidity 5 50°C, 90%RH, 120 hrs Non-Operating $-30^{\circ}C \leftrightarrow 70^{\circ}C$ Temperature Shock Non-Operating 6 (0.5hr each), 25 cycles Frequency:0 ~ 55 Hz Amplitude:1.5 mm Sweep Time:11min 7 Vibration Test Non-Operating Test Period:6 Cycles for each Direction of X,Y,Z 150pF,330Ω Electro-static Discharge 9 Air:± 8KV;Contact: ±4KV Non-Operating 10 times/point;4 points/panel face

Note1: The test sample have recovery time for 24 hours at room temperature before the

function check. In the standard conditions, there is no any touch panel function NG issue occurred.

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8.3 JUDGMENT STANDARD

The judgment of the above test should be made as follow:

- Pass: Normal display image with no obvious non-uniformity and no line defect. Partial transformation of the module parts should be ignored.
- Fail: No display image, obvious non-uniformity, or line defects.



8.4 INCOMING INSPECTION STANDARDS

No.	Parameter				Criteria				
110.	i ulumotor	Display function	on: No D	ispla			jor)		
		Contrast ratio					J ••• /		
		Does not mee				he spec. (Maior)	(Note:3)	
		Line Defect: N	lo obvio	us Ve	ertical an	nd Horizon	tal line	defect in	briaht.
						r) (Note:1			
		Point Defect :							
				-	eptable r				
		lt	em	<u> </u>	1		Tota	1	
					Active A	rea			
		Br	ight		2		5		
		D	ark		4		5		
					-	í]	
1	Operating								
	Operating		v. Visible	a thur			(Miner)		
		Non-uniformit Foreign mate							
					or wrnite		· · · ·	~ 1/4L)	-
			Zone	Acc	eptable	Class	S	AQL	
					Imber	Of		Level	
		Dimen				Defec	ts		
		D>	0.5		0				
		0.3 <	$D \le 0.5$		5	Mino	r 🗌	1.5	
		D ≤	0.3		*				
		D = (Lo	ong + Sh	ort) /	2 *:	Disregard			
		Foreign Mate						Note: 4)	
				Zone			Class		
					AC	ceptable	Of	AQL	
		L (mm)	W(mn	n)	<u> </u>	number	Defec	ts Leve	•
		L >5		v>0.1		0			1
		0.5 < L ≤ 5	0.03	< W <	⊴0.1	5	Mino	r 1.5	
		L ⊴0.5	_	≤0.0		*			
		L : Length		Width		Disregard	l		
		Dimension: (
		Bezel appea				.)			
		Scratch on the				/			
					Accepta	Clas	s	AQL	
					ble	Of Def		Level	
		L (mm)	W(mm		number				
					0	Mine	or	1.5	
		L ≤ 3	W≤0		3	1			
			1120		<u> </u>			I	
	External Inspection	L : Lengt	h \//·	\ <u>\</u> /id+	h ∗·D	isregard			
2	(non-operating)	Dent or bubble							
4	(non-operating)	· · · · · · · · · · · · · · · · · · ·	ne			Class			
					eptable	Of	AQ		
		Dimens	on	nu	umber	Defects	Lev	/el	
		Dimens			*				
			0.5		3	Minor	1.	5	
		<u>D</u> ≤	0.0		5				
		D = (l e r)	a + Char	+)/2		* · Dier	ogard		
		D = (Long	y + Shor	972		* : Disr	eyard		

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			Definition
Class of Major			It is a defect that is likely to result in failure or to reduce materially the
defects	Major	AQL 0.05%	usability of the product for the intended function.
uciects			It is a defect that will not result in functioning problem with deviation
Minor		AQL 1.5%	classified.

Note1:

(a)Bright point defect is defined as point defect of R,G,B with area >1/2 pixel respectively (b)Dark point defect is defined as visible in full white pattern.

(c)Definition of distribution of point defect is as follows:

-minimum separation between dark point defects should be larger than 5mm.

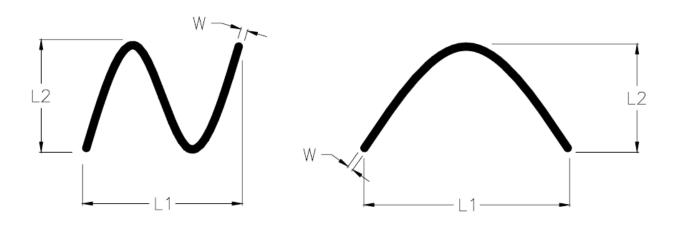
-minimum separation between bright point defects should be larger than 5mm.

- (d)Definition of joined bright point defect and joined dark point defect are as follows:
 - -Two or more joined bright point defects must be nil.
 - -Three joined dark point defects must be nil.
 - -Coupling of one dark and one bright point in junction is counted as one dark and bright spot with 1 pair maximum.
 - -Two Joined dark point is counted as two dark points with 2 pair maximum.

Note2: The external inspection should be conducted at the distance $30\pm$ 5cm between the eyes of inspector and the panel.

Note3: Luminance measurement for contrast ratio is at the distance $50\pm$ 5cm between the detective head and the panel with ambient luminance less than 1 lux. Contrast ratio is obtained at optimum view angle.

Note4: W-Width in mm , L-length of Max.(L1,L2) in mm.



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8.5 Sampling Condition

Unless otherwise agree in written, the sampling inspection shall be applied to the incoming inspection of customer.

Lot size: Quantity of shipment lot per model.

Sampling type: normal inspection, single sampling

Sampling table: MIL-STD-105E

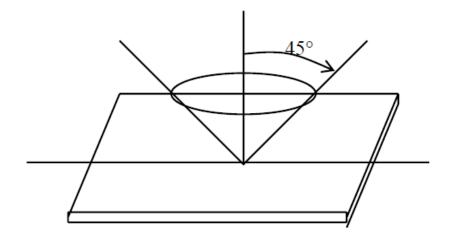
Inspection level: Level II

8.6 Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.

 $\theta \leq 45^{\circ}$ inspection under non-operating condition.

 $\theta \! \leq \! \mathbf{5}^{\circ}$ inspection under operating condition





- 9. PRECAUTION RELATING PRODUCT HANDLING
 - 9.1 SAFETY
 - 9.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
 - 9.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.
 - 9.2 HANDLING
 - 9.2.1 Avoid any strong mechanical shock which can break the glass.
 - 9.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
 - 9.2.3 Do not remove the panel or frame from the module.
 - 9.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, Do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
 - 9.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
 - 9.2.6 Do not touch the display area with bare hands , this will stain the display area.
 - 9.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
 - 9.2.8 To control temperature and time of soldering is $280 \pm 10^{\circ}$ C and 3-5 sec.
 - 9.2.9 To avoid liquid (include organic solvent) stained on LCM.
 - 9.3 STORAGE
 - 9.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
 - 9.3.2 Do not place the module near organics solvents or corrosive gases.
 - 9.3.3 Do not crush, shake, or jolt the module.

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